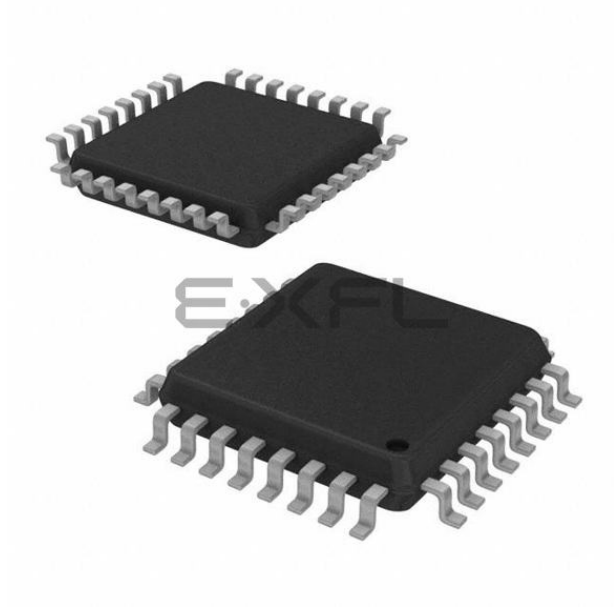

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-8FX
Core Size	8-Bit
Speed	16MHz
Connectivity	I²C, LINbus, SIO, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	28
Program Memory Size	36KB (36K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.4V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb95f636hpmc-g-sne2

MB95630H Series

New 8FX 8-bit Microcontrollers

The MB95630H Series is a series of general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers of this series contain a variety of peripheral functions.

Features

- F²MC-8FX CPU core
  - Instruction set optimized for controllers
    - Multiplication and division instructions
    - 16-bit arithmetic operations
    - Bit test branch instructions
    - Bit manipulation instructions, etc.
- Clock
  - Selectable main clock source
    - Main oscillation clock (up to 16.25 MHz, maximum machine clock frequency: 8.125 MHz)
    - External clock (up to 32.5 MHz, maximum machine clock frequency: 16.25 MHz)
    - Main CR clock (4 MHz ±2%)
    - Main CR PLL clock
      - The main CR PLL clock frequency becomes 8 MHz ±2% when the PLL multiplication rate is 2.
      - The main CR PLL clock frequency becomes 10 MHz ±2% when the PLL multiplication rate is 2.5.
      - The main CR PLL clock frequency becomes 12 MHz ±2% when the PLL multiplication rate is 3.
      - The main CR PLL clock frequency becomes 16 MHz ±2% when the PLL multiplication rate is 4.
  - Selectable subclock source
    - Suboscillation clock (32.768 kHz)
    - External clock (32.768 kHz)
    - Sub-CR clock (Typ: 100 kHz, Min: 50 kHz, Max: 150 kHz)
- Timer
  - 8/16-bit composite timer × 2 channels
  - 8/16-bit PPG × 3 channels
  - 16-bit PPG timer × 1 channel (can work independently or together with the multi-pulse generator)
  - 16-bit reload timer × 1 channel (can work independently or together with the multi-pulse generator)
  - Time-base timer × 1 channel
  - Watch prescaler × 1 channel
- UART/SIO × 1 channel
  - Full duplex double buffer
  - Capable of clock asynchronous (UART) serial data transfer and clock synchronous (SIO) serial data transfer
- I²C bus interface × 1 channel
  - Built-in wake-up function
- Multi-pulse generator (MPG) (for DC motor control) × 1 channel
  - 16-bit reload timer × 1 channel
  - 16-bit PPG timer × 1 channel
  - Waveform sequencer (including a 16-bit timer equipped with a buffer and a compare clear function)
- LIN-UART
  - Full duplex double buffer
  - Capable of clock asynchronous serial data transfer and clock synchronous serial data transfer
- External interrupt × 10 channels
  - Interrupt by edge detection (rising edge, falling edge, and both edges can be selected)
  - Can be used to wake up the device from different low power consumption (standby) modes
- 8/10-bit A/D converter × 8 channels
  - 8-bit or 10-bit resolution can be selected.
- Low power consumption (standby) modes
  - There are four standby modes as follows:
    - Stop mode
    - Sleep mode
    - Watch mode
    - Time-base timer mode
  - In standby mode, two further options can be selected: normal standby mode and deep standby mode.
- I/O port
  - MB95F632H/F633H/F634H/F636H (number of I/O ports: 28)
    - General-purpose I/O ports (CMOS I/O): 25
    - General-purpose I/O ports (N-ch open drain): 3
  - MB95F632K/F633K/F634K/F636K (number of I/O ports: 29)
    - General-purpose I/O ports (CMOS I/O): 25
    - General-purpose I/O ports (N-ch open drain): 4
- On-chip debug
  - 1-wire serial control
  - Serial writing supported (asynchronous mode)
- Hardware/software watchdog timer
  - Built-in hardware watchdog timer
  - Built-in software watchdog timer
- Power-on reset
  - A power-on reset is generated when the power is switched on.
- Low-voltage detection reset circuit (only available on MB95F632K/F633K/F634K/F636K)
  - Built-in low-voltage detection function (The combination of detection voltage and release voltage can be selected from four options.)
- Comparator
- Clock supervisor counter
  - Built-in clock supervisor counter
- Dual operation Flash memory
  - The program/erase operation and the read operation can be executed in different banks (upper bank/lower bank) simultaneously.
- Flash memory security function
  - Protects the content of the Flash memory.

9. Pin Connection

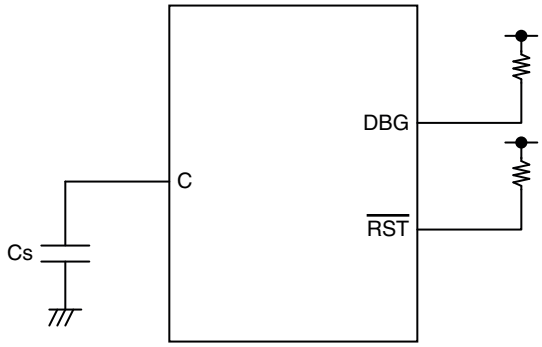
- Treatment of unused pins
  If an unused input pin is left unconnected, a component may be permanently damaged due to malfunctions or latch-ups. Always pull up or pull down an unused input pin through a resistor of at least 2 kΩ. Set an unused input/output pin to the output state and leave it unconnected, or set it to the input state and treat it the same as an unused input pin. If there is an unused output pin, leave it unconnected.

- Power supply pins
  To reduce unnecessary electro-magnetic emission, prevent malfunctions of strobe signals due to an increase in the ground level, and conform to the total output current standard, always connect the V_{CC} pin and the V_{SS} pin to the power supply and ground outside the device. In addition, connect the current supply source to the V_{CC} pin and the V_{SS} pin with low impedance.
  It is also advisable to connect a ceramic capacitor of approximately 0.1 µF as a bypass capacitor between the V_{CC} pin and the V_{SS} pin at a location close to this device.

- DBG pin
  Connect the DBG pin to an external pull-up resistor of 2 kΩ or above.
  After power-on, ensure that the DBG pin does not stay at “L” level until the reset output is released.
  The DBG pin becomes a communication pin in debug mode. Since the actual pull-up resistance depends on the tool used and the interconnection length, refer to the tool document when selecting a pull-up resistor.

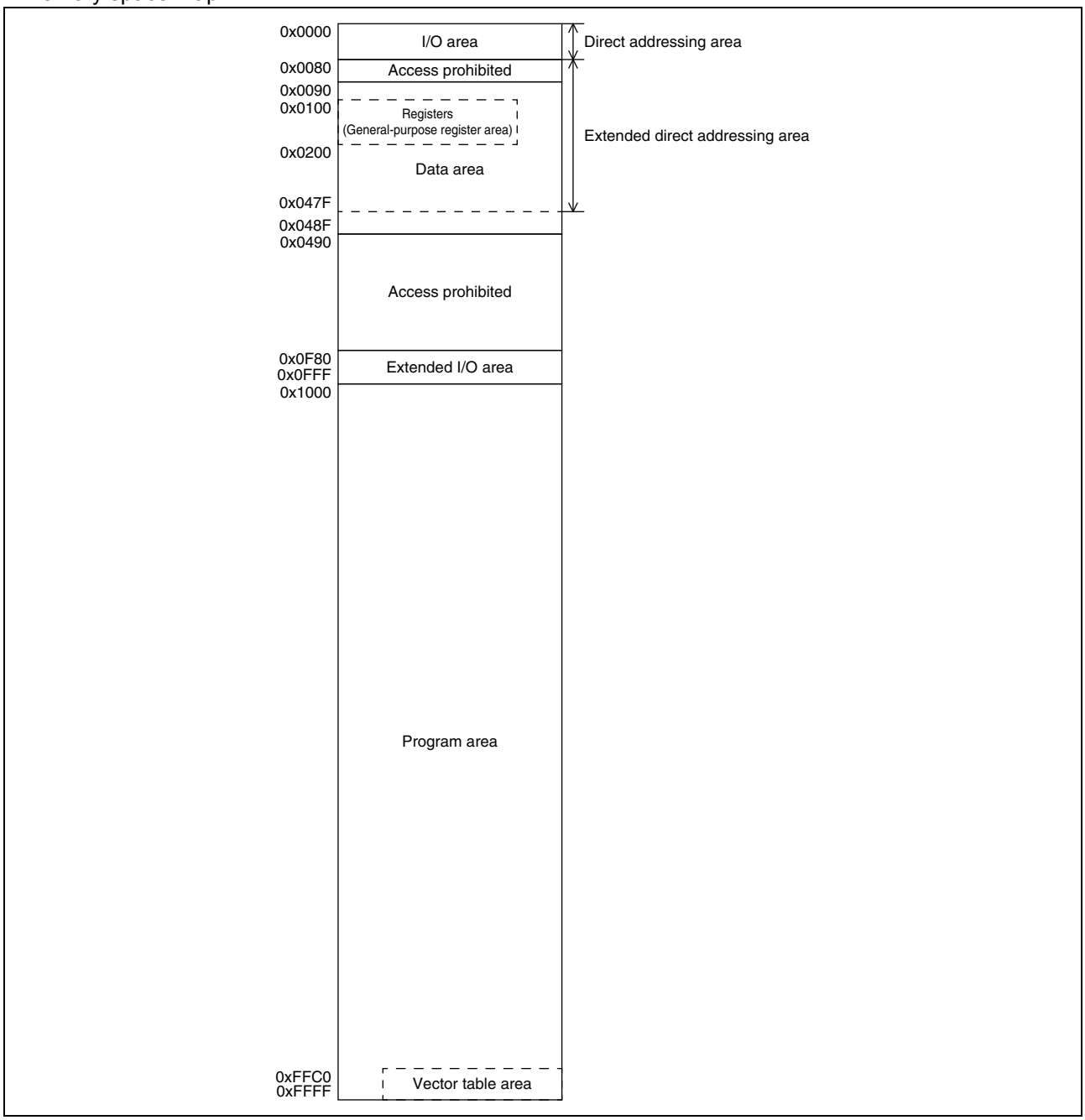
- $\overline{RST}$ pin
  Connect the $\overline{RST}$ pin to an external pull-up resistor of 2 kΩ or above.
  To prevent the device from unintentionally entering the reset mode due to noise, minimize the interconnection length between a pull-up resistor and the $\overline{RST}$ pin and that between a pull-up resistor and the V_{CC} pin when designing the layout of the printed circuit board.
  The PF2/$\overline{RST}$ pin functions as the reset input/output pin after power-on. In addition, the reset output of the PF2/$\overline{RST}$ pin can be enabled by the RSTOE bit in the SYSC register, and the reset input function and the general-purpose I/O function can be selected by the RSTEN bit in the SYSC register.
- C pin
  Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The decoupling capacitor for the V_{CC} pin must have a capacitance equal to or larger than the capacitance of C_S. For the connection to a decoupling capacitor C_S, see the diagram below. To prevent the device from unintentionally entering a mode to which the device is not set to transit due to noise, minimize the distance between the C pin and C_S and the distance between C_S and the V_{SS} pin when designing the layout of a printed circuit board.

- DBG/$\overline{RST}$/C pins connection diagram



- Note on serial communication
  In serial communication, reception of wrong data may occur due to noise or other causes. Therefore, design a printed

- Memory space map



13. Areas For Specific Applications

The general-purpose register area and vector table area are used for the specific applications.

- General-purpose register area (Addresses: 0x0100 to 0x01FF*1)
  - This area contains the auxiliary registers used for 8-bit arithmetic operations, transfer, etc.
  - As this area forms part of the RAM area, it can also be used as conventional RAM.
  - When the area is used as general-purpose registers, general-purpose register addressing enables high-speed access with short instructions.

- Non-volatile register data area (Addresses: 0xFFBB to 0xFFBF)
  - The area from 0xFFBB to 0xFFBF is used to store data of the non-volatile register. For details, refer to “CHAPTER 26 NON-VOLATILE REGISTER (NVR) INTERFACE” in “New 8FX MB95630H Series Hardware Manual”.

- Vector table area (Addresses: 0xFFC0 to 0xFFFF)
  - This area is used as the vector table for vector call instructions (CALLV), interrupts, and resets.
  - The top of the Flash memory area is allocated to the vector table area. The start address of a service routine is set to an address in the vector table in the form of data.

  “Interrupt Source Table” lists the vector table addresses corresponding to vector call instructions, interrupts, and resets.
  For details, refer to “CHAPTER 4 RESET”, “CHAPTER 5 INTERRUPTS” and “A.2 Special Instruction ■ Special Instruction ● CALLV #vct” in “New 8FX MB95630H Series Hardware Manual”.

- Direct bank pointer and access area

Direct bank pointer (DP[2:0])	Operand-specified dir	Access area
0bXXX (It does not affect mapping.)	0x0000 to 0x007F	0x0000 to 0x007F
0b000 (Initial value)	0x0090 to 0x00FF	0x0090 to 0x00FF
0b001	0x0080 to 0x00FF	0x0100 to 0x017F
0b010		0x0180 to 0x01FF*1
0b011		0x0200 to 0x027F
0b100		0x0280 to 0x02FF*2
0b101		0x0300 to 0x037F
0b110		0x0380 to 0x03FF
0b111		0x0400 to 0x047F

*1: Due to the memory size limit, the available access area is up to “0x018F” in MB95F632H/F632K.
*2: Due to the memory size limit, the available access area is up to “0x028F” in MB95F633H/F633K.

14. I/O Map

Address	Register abbreviation	Register name	R/W	Initial value
0x0000	PDR0	Port 0 data register	R/W	0b00000000
0x0001	DDR0	Port 0 direction register	R/W	0b00000000
0x0002	PDR1	Port 1 data register	R/W	0b00000000
0x0003	DDR1	Port 1 direction register	R/W	0b00000000
0x0004	—	(Disabled)	—	—
0x0005	WATR	Oscillation stabilization wait time setting register	R/W	0b11111111
0x0006	PLLC	PLL control register	R/W	0b000X0000
0x0007	SYCC	System clock control register	R/W	0bXXX11011
0x0008	STBC	Standby control register	R/W	0b00000000
0x0009	RSRR	Reset source register	R/W	0b000XXXXX
0x000A	TBTC	Time-base timer control register	R/W	0b00000000
0x000B	WPCR	Watch prescaler control register	R/W	0b00000000
0x000C	WDTC	Watchdog timer control register	R/W	0b00XX0000
0x000D	SYCC2	System clock control register 2	R/W	0bXXXX0011
0x000E	STBC2	Standby control register 2	R/W	0b00000000
0x000F to 0x0015	—	(Disabled)	—	—
0x0016	PDR6	Port 6 data register	R/W	0b00000000
0x0017	DDR6	Port 6 direction register	R/W	0b00000000
0x0018 to 0x0027	—	(Disabled)	—	—
0x0028	PDRF	Port F data register	R/W	0b00000000
0x0029	DDRF	Port F direction register	R/W	0b00000000
0x002A	PDRG	Port G data register	R/W	0b00000000
0x002B	DDRG	Port G direction register	R/W	0b00000000
0x002C	PUL0	Port 0 pull-up register	R/W	0b00000000
0x002D	PUL1	Port 1 pull-up register	R/W	0b00000000
0x002E to 0x0032	—	(Disabled)	—	—
0x0033	PUL6	Port 6 pull-up register	R/W	0b00000000
0x0034	—	(Disabled)	—	—
0x0035	PULG	Port G pull-up register	R/W	0b00000000
0x0036	T01CR1	8/16-bit composite timer 01 status control register 1	R/W	0b00000000

Address	Register abbreviation	Register name	R/W	Initial value
0x0FA8	TMRH1	16-bit reload timer timer register (upper)	R/W	0b00000000
	TMRLRH1	16-bit reload timer reload register (upper)		
0x0FA9	TMRL1	16-bit reload timer timer register (lower)	R/W	0b00000000
	TMRLRL1	16-bit reload timer reload register (lower)		
0x0FAA	PDS21	8/16-bit PPG21 duty setting buffer register	R/W	0b11111111
0x0FAB	PDS20	8/16-bit PPG20 duty setting buffer register	R/W	0b11111111
0x0FAC to 0x0FAF	—	(Disabled)	—	—
0x0FB0	PDCRH1	16-bit PPG downcounter register (upper)	R	0b00000000
0x0FB1	PDCRL1	16-bit PPG downcounter register (lower)	R	0b00000000
0x0FB2	PCSRH1	16-bit PPG cycle setting buffer register (upper)	R/W	0b11111111
0x0FB3	PCSRL1	16-bit PPG cycle setting buffer register (lower)	R/W	0b11111111
0x0FB4	PDUTH1	16-bit PPG duty setting buffer register (upper)	R/W	0b11111111
0x0FB5	PDUTL1	16-bit PPG duty setting buffer register (lower)	R/W	0b11111111
0x0FB6 to 0x0FBB	—	(Disabled)	—	—
0x0FBC	BGR1	LIN-UART baud rate generator register 1	R/W	0b00000000
0x0FBD	BGR0	LIN-UART baud rate generator register 0	R/W	0b00000000
0x0FBE	PSSR0	UART/SIO dedicated baud rate generator prescaler select register	R/W	0b00000000
0x0FBF	BRSR0	UART/SIO dedicated baud rate generator baud rate setting register	R/W	0b00000000
0x0FC0 to 0x0FC2	—	(Disabled)	—	—
0x0FC3	AIDRL	A/D input disable register (lower)	R/W	0b00000000
0x0FC4	OPDBRH0	16-bit MPG output data buffer register (upper) ch. 0	R/W	0b00000000
0x0FC5	OPDBRL0	16-bit MPG output data buffer register (lower) ch. 0	R/W	0b00000000
0x0FC6	OPDBRH1	16-bit MPG output data buffer register (upper) ch. 1	R/W	0b00000000
0x0FC7	OPDBRL1	16-bit MPG output data buffer register (lower) ch. 1	R/W	0b00000000
0x0FC8	OPDBRH2	16-bit MPG output data buffer register (upper) ch. 2	R/W	0b00000000
0x0FC9	OPDBRL2	16-bit MPG output data buffer register (lower) ch. 2	R/W	0b00000000
0x0FCA	OPDBRH3	16-bit MPG output data buffer register (upper) ch. 3	R/W	0b00000000
0x0FCB	OPDBRL3	16-bit MPG output data buffer register (lower) ch. 3	R/W	0b00000000
0x0FCC	OPDBRH4	16-bit MPG output data buffer register (upper) ch. 4	R/W	0b00000000
0x0FCD	OPDBRL4	16-bit MPG output data buffer register (lower) ch. 4	R/W	0b00000000

- R/W access symbols
  R/W : Readable/Writable
  R : Read only
- Initial value symbols
  0 : The initial value of this bit is “0”.
  1 : The initial value of this bit is “1”.
  X : The initial value of this bit is undefined.

Note: Do not write to an address that is “(Disabled)”. If a “(Disabled)” address is read, an indeterminate value is returned.

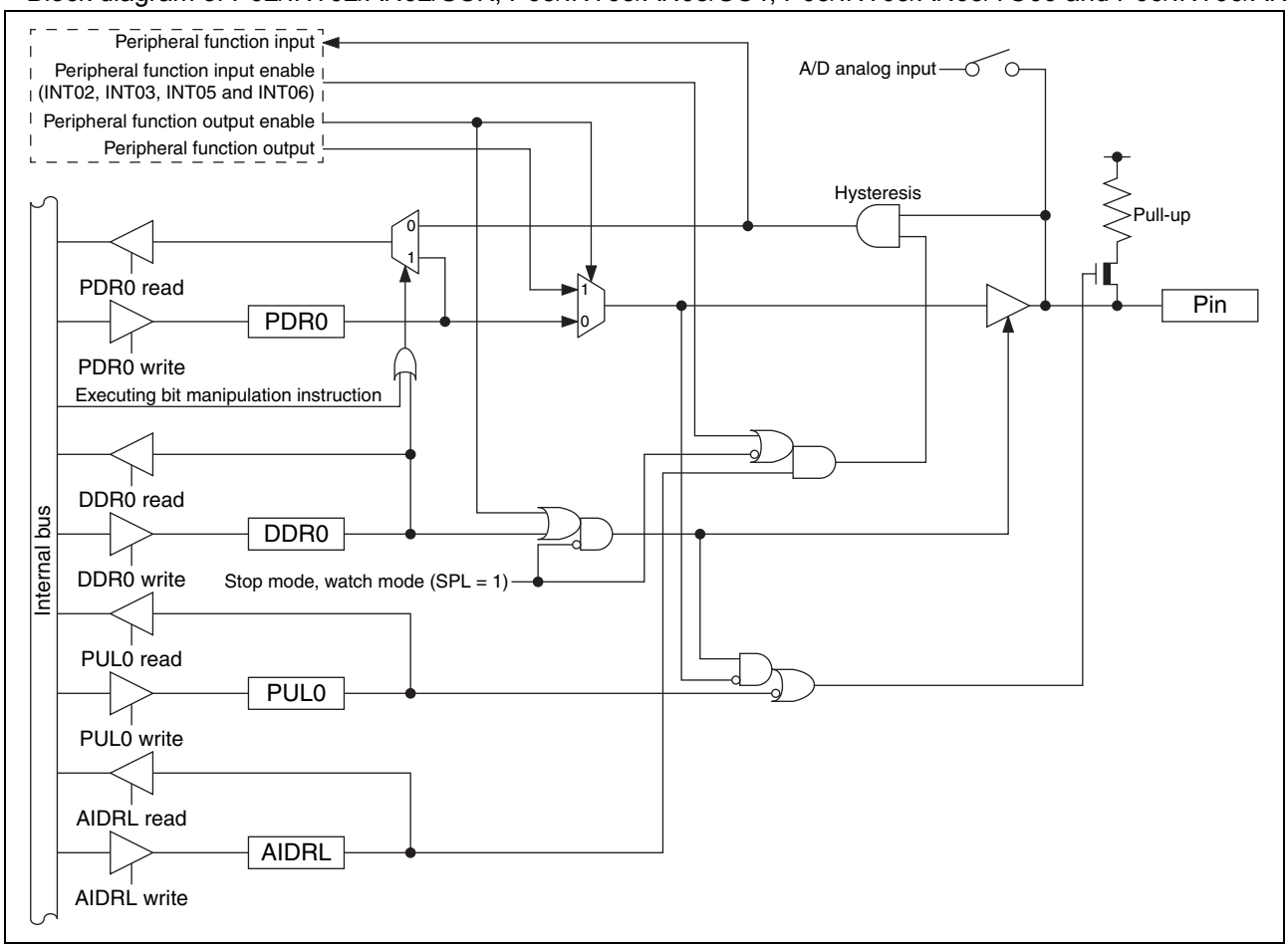
15. I/O Ports

- List of port registers

Register name		Read/Write	Initial value
Port 0 data register	PDR0	R, RM/W	0b00000000
Port 0 direction register	DDR0	R/W	0b00000000
Port 1 data register	PDR1	R, RM/W	0b00000000
Port 1 direction register	DDR1	R/W	0b00000000
Port 6 data register	PDR6	R, RM/W	0b00000000
Port 6 direction register	DDR6	R/W	0b00000000
Port F data register	PDRF	R, RM/W	0b00000000
Port F direction register	DDRF	R/W	0b00000000
Port G data register	PDRG	R, RM/W	0b00000000
Port G direction register	DDRG	R/W	0b00000000
Port 0 pull-up register	PUL0	R/W	0b00000000
Port 1 pull-up register	PUL1	R/W	0b00000000
Port 6 pull-up register	PUL6	R/W	0b00000000
Port G pull-up register	PULG	R/W	0b00000000
A/D input disable register (lower)	AIDRL	R/W	0b00000000

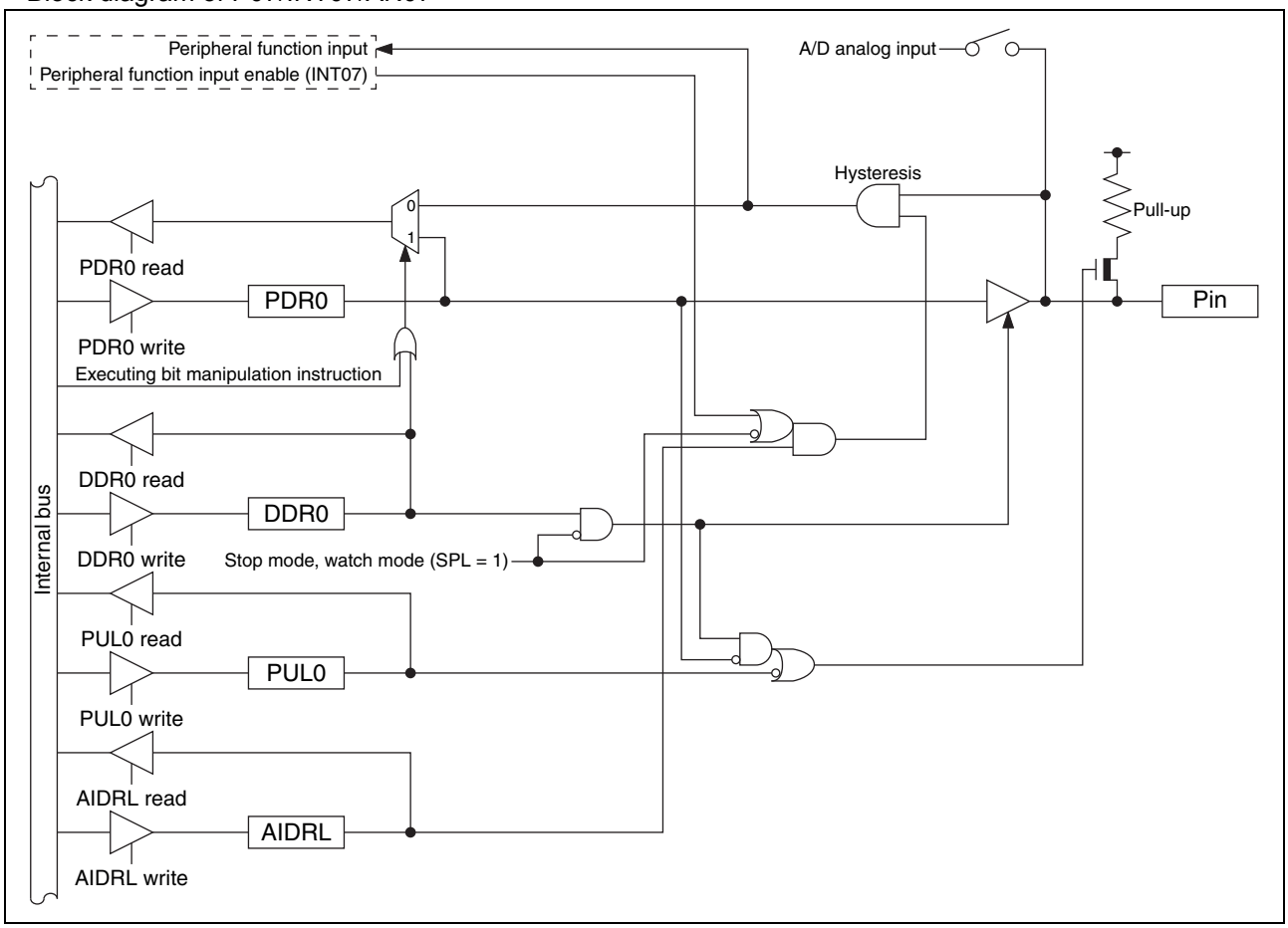
R/W : Readable/writable (The read value is the same as the write value.)
R, RM/W : Readable/writable (The read value is different from the write value. The write value is read by the read-modify-write (RMW) type of instruction.)

- Block diagram of P02/INT02/AN02/SCK, P03/INT03/AN03/SOT, P05/INT05/AN05/TO00 and P06/INT06/AN06/TO01



- P07/INT07/AN07 pin
  This pin has the following peripheral functions:
  - External interrupt circuit input pin (INT07)
  - 8/10-bit A/D converter analog input pin (AN07)

- Block diagram of P07/INT07/AN07



15.3.4 Port 6 operations

- Operation as an output port
  - A pin becomes an output port if the bit in the DDR6 register corresponding to that pin is set to “1”.
  - For a pin shared with other peripheral functions, disable the output of such peripheral functions.
  - When a pin is used as an output port, it outputs the value of the PDR6 register to external pins.
  - If data is written to the PDR6 register, the value is stored in the output latch and is output to the pin set as an output port as it is.
  - Reading the PDR6 register returns the PDR6 register value.

- Operation as an input port
  - A pin becomes an input port if the bit in the DDR6 register corresponding to that pin is set to “0”.
  - For a pin shared with other peripheral functions, disable the output of such peripheral functions.
  - If data is written to the PDR6 register, the value is stored in the output latch but is not output to the pin set as an input port.
  - Reading the PDR6 register returns the pin value. However, if the read-modify-write (RMW) type of instruction is used to read the PDR6 register, the PDR6 register value is returned.

- Operation as a peripheral function output pin
  - A pin becomes a peripheral function output pin if the peripheral output function is enabled by setting the output enable bit of a peripheral function corresponding to that pin.
  - The pin value can be read from the PDR6 register even if the peripheral function output is enabled. Therefore, the output value of a peripheral function can be read by the read operation on the PDR6 register. However, if the read-modify-write (RMW) type of instruction is used to read the PDR6 register, the PDR6 register value is returned.

- Operation as a peripheral function input pin
  - To set a pin as an input port, set the bit in the DDR6 register corresponding to the input pin of a peripheral function to “0”.
  - Reading the PDR6 register returns the pin value, regardless of whether the peripheral function uses that pin as its input pin. However, if the read-modify-write (RMW) type of instruction is used to read the PDR6 register, the PDR6 register value is returned.

- Operation at reset
  If the CPU is reset, all bits in the DDR6 register are initialized to “0” and port input is enabled.

- Operation in stop mode and watch mode
  - If the pin state setting bit in the standby control register (STBC:SPL) is set to “1” and the device transits to stop mode or watch mode, the pin is compulsorily made to enter the high impedance state regardless of the DDR6 register value. The input of that pin is locked to “L” level and blocked in order to prevent leaks due to input open. However, if the interrupt input from the external interrupt (INT08, INT09) is enabled, or if the interrupt input of P64/EC1 and P67/TRG1 is enabled by the external interrupt control register ch. 0 (EIC00) of the external interrupt circuit and the interrupt pin selection circuit control register (WICR) of the interrupt pin selection circuit, the input is enabled and is not blocked.
  - If the pin state setting bit is “0”, the state of the port I/O or that of the peripheral function I/O remains unchanged and the output level is maintained.

- Operation of the pull-up register
  Setting the bit in the PUL6 register to “1” makes the pull-up resistor be internally connected to the pin. When the pin output is “L” level, the pull-up resistor is disconnected regardless of the value of the PUL6 register.

- Operation as an input port
  - A pin becomes an input port if the bit in the DDRF register corresponding to that pin is set to “0”.
  - For a pin shared with other peripheral functions, disable the output of such peripheral functions.
  - If data is written to the PDRF register, the value is stored in the output latch but is not output to the pin set as an input port.
  - Reading the PDRF register returns the pin value. However, if the read-modify-write (RMW) type of instruction is used to read the PDRF register, the PDRF register value is returned.

- Operation at reset
  If the CPU is reset, all bits in the DDRF register are initialized to “0” and port input is enabled.

- Operation in stop mode and watch mode
  - If the pin state setting bit in the standby control register (STBC:SPL) is set to “1” and the device transits to stop mode or watch mode, the pin is compulsorily made to enter the high impedance state regardless of the DDRF register value. The input of that pin is locked to “L” level and blocked in order to prevent leaks due to input open.
  - If the pin state setting bit is “0”, the state of the port I/O or that of the peripheral function I/O remains unchanged and the output level is maintained.

15.5 Port G

Port G is a general-purpose I/O port. This section focuses on its functions as a general-purpose I/O port. For details of peripheral functions, refer to their respective chapters in “New 8FX MB95630H Series Hardware Manual”.

15.5.1 Port G configuration

Port G is made up of the following elements.

- General-purpose I/O pins/peripheral function I/O pins
- Port G data register (PDRG)
- Port G direction register (DDRG)
- Port G pull-up register (PULG)

15.5.2 Block diagram of port G

- PG1/X0A/SNI1 pin
  This pin has the following peripheral functions:
  - Subclock input oscillation pin (X0A)
  - Trigger input pin for the position detection function of the MPG waveform sequencer (SNI1)

- PG2/X1A/SNI2 pin
  This pin has the following peripheral functions:
  - Subclock I/O oscillation pin (X1A)
  - Trigger input pin for the position detection function of the MPG waveform sequencer (SNI2)

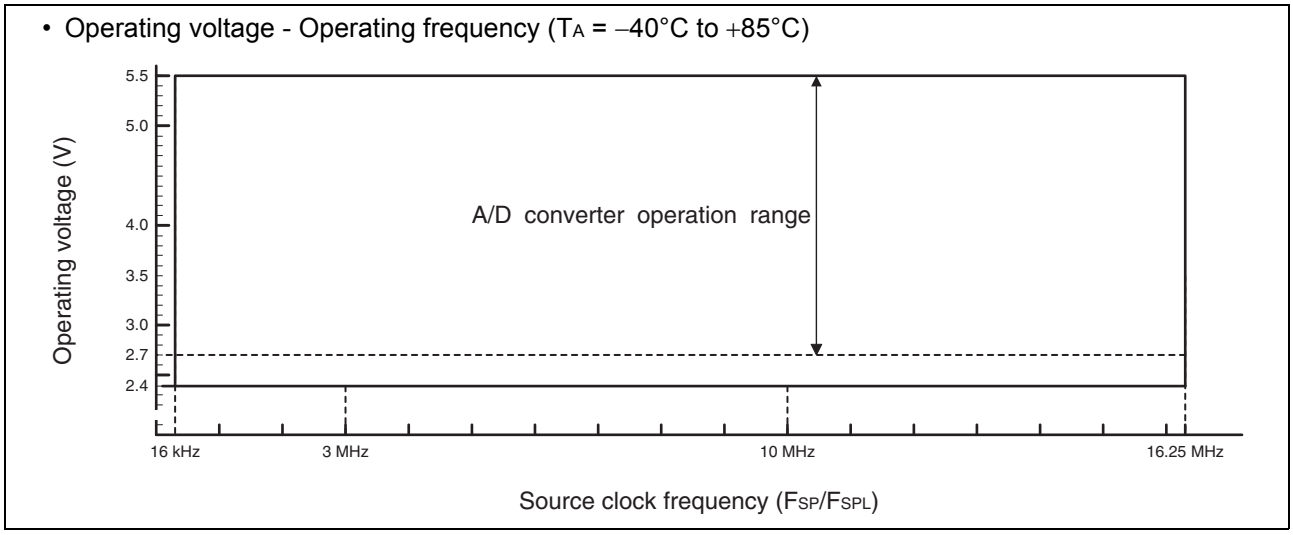
Pin name	Normal operation	Sleep mode	Stop mode		Watch mode		On reset
			SPL=0	SPL=1	SPL=0	SPL=1	
P14/UCK0/ PPG01	I/O port/ peripheral function I/O	I/O port/ peripheral function I/O	- Previous state kept - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Previous state kept - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z - Input enabled*1 (However, it does not function.)
P15/UO0/ PPG20	I/O port/ peripheral function I/O	I/O port/ peripheral function I/O	- Previous state kept - Input blocked*2	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2	- Previous state kept - Input blocked*2	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2	- Hi-Z - Input enabled*1 (However, it does not function.)
P16/UI0/ PPG21	I/O port/ peripheral function I/O	I/O port/ peripheral function I/O	- Previous state kept - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Previous state kept - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z - Input enabled*1 (However, it does not function.)
P17/TO1/ SNI0	I/O port/ peripheral function I/O	I/O port/ peripheral function I/O	- Previous state kept - Input blocked*2	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2	- Previous state kept - Input blocked*2	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2	- Hi-Z - Input enabled*1 (However, it does not function.)
P00/INT00/ AN00/ CMP0_P	I/O port/ peripheral function I/O/ analog input	I/O port/ peripheral function I/O/ analog input	- Previous state kept - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Previous state kept - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z (However, the setting of the pull-up control is effective.) - Input blocked*2 (However, an external interrupt can be input when the external interrupt request is enabled.)	- Hi-Z - Input blocked*2
P01/INT01/ AN01/ CMP0_N							
P02/INT02/ AN02/SCK							
P03/INT03/ AN03/SOT							

18. Electrical Characteristics

18.1 Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V_{CC}	V_{SS} – 0.3	V_{SS} + 6	V	
Input voltage*1	V_I	V_{SS} – 0.3	V_{SS} + 6	V	*2
Output voltage*1	V_O	V_{SS} – 0.3	V_{SS} + 6	V	*2
Maximum clamp current	I_{CLAMP}	–2	+2	mA	Applicable to specific pins*3
Total maximum clamp current	$\Sigma\lvert I_{CLAMP}\rvert$	—	20	mA	Applicable to specific pins*3
“L” level maximum output current	I_{OL}	—	15	mA	
“L” level average current	I_{OLAV1}	—	4	mA	Other than P62 to P67 Average output current = operating current × operating ratio (1 pin)
	I_{OLAV2}		12		P62 to P67 Average output current = operating current × operating ratio (1 pin)
“L” level total maximum output current	ΣI_{OL}	—	100	mA	
“L” level total average output current	ΣI_{OLAV}	—	37	mA	Total average output current = operating current × operating ratio (Total number of pins)
“H” level maximum output current	I_{OH}	—	–15	mA	
“H” level average current	I_{OHAV1}	—	–4	mA	Other than P62 to P67 Average output current = operating current × operating ratio (1 pin)
	I_{OHAV2}		–8		P62 to P67 Average output current = operating current × operating ratio (1 pin)
“H” level total maximum output current	ΣI_{OH}	—	–100	mA	
“H” level total average output current	ΣI_{OHAV}	—	–47	mA	Total average output current = operating current × operating ratio (Total number of pins)
Power consumption	P_d	—	320	mW	
Operating temperature	T_A	–40	+85	°C	
Storage temperature	T_{stg}	–55	+150	°C	

*1: These parameters are based on the condition that V_{SS} is 0.0 V.
*2: V_I and V_O must not exceed V_{CC} + 0.3 V. V_I must not exceed the rated voltage. However, if the maximum current to/from an input is limited by means of an external component, the I_{CLAMP} rating is used instead of the V_I rating.
*3: Specific pins: P00 to P07, P10, P11, P13 to P17, P62 to P67, PF0, PF1, PG1, PG2

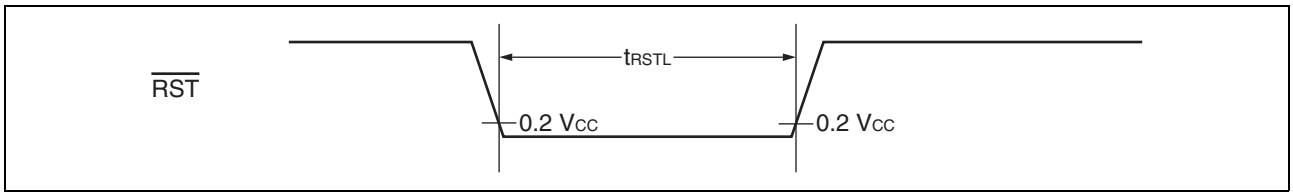


18.4.3 External Reset

(V_{CC} = 5.0 V±10%, V_{SS} = 0.0 V, T_A = –40°C to +85°C)

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
RST "L" level pulse width	t_{RSTL}	2 t_{MCLK}*	—	ns	

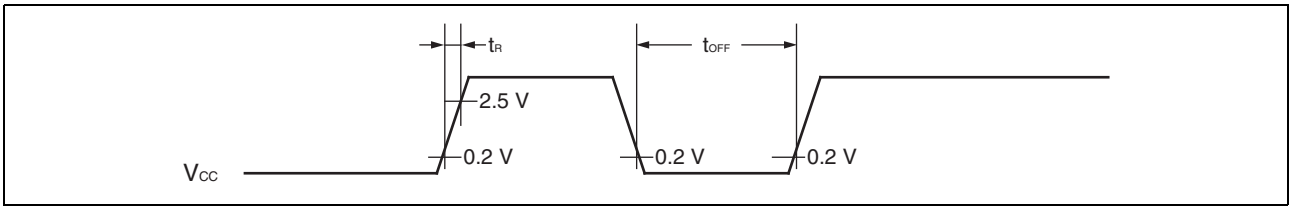
*: See "Source Clock/Machine Clock" for t_{MCLK}.



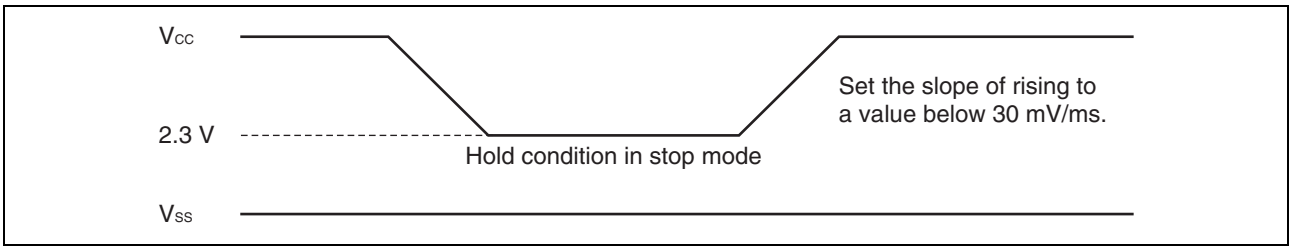
18.4.4 Power-on Reset

(V_{SS} = 0.0 V, T_A = –40°C to +85°C)

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
Power supply rising time	t_R	—	—	50	ms	
Power supply cutoff time	t_{OFF}	—	1	—	ms	Wait time until power-on



Note: A sudden change of power supply voltage may activate the power-on reset function. When changing the power supply voltage during the operation, set the slope of rising to a value below within 30 mV/ms as shown below.

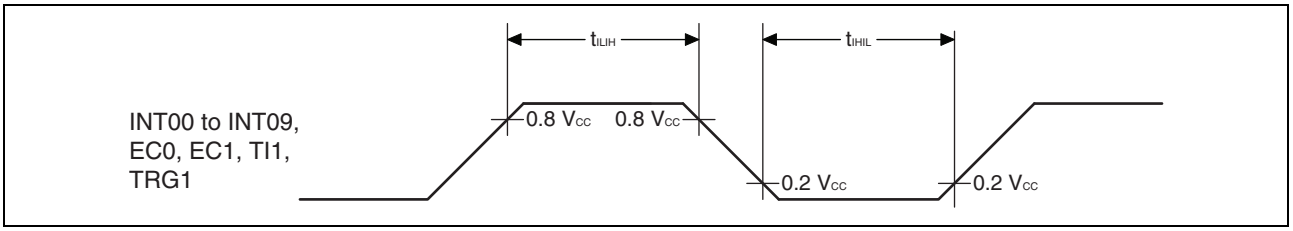


18.4.5 Peripheral Input Timing

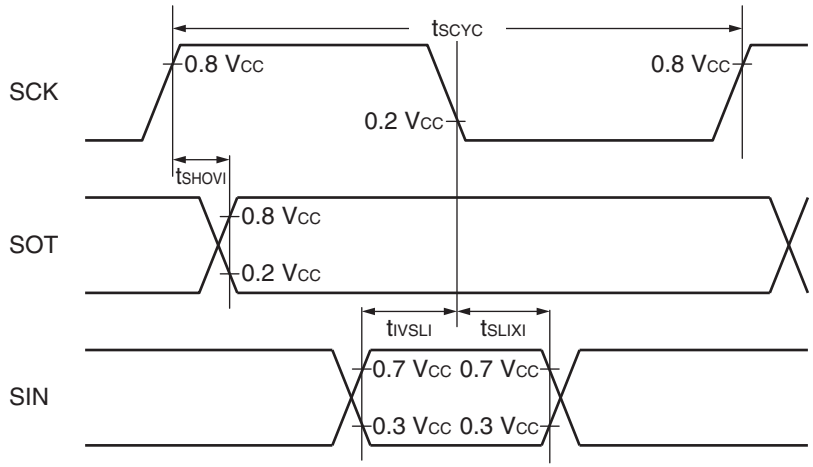
(V_{CC} = 5.0 V±10%, V_{SS} = 0.0 V, T_A = –40°C to +85°C)

Parameter	Symbol	Pin name	Value		Unit
			Min	Max	
Peripheral input “H” pulse width	t_{ILIH}	INT00 to INT09, EC0, EC1, TI1, TRG1	2 t_{MCLK}*	—	ns
Peripheral input “L” pulse width	t_{IHIL}		2 t_{MCLK}*	—	ns

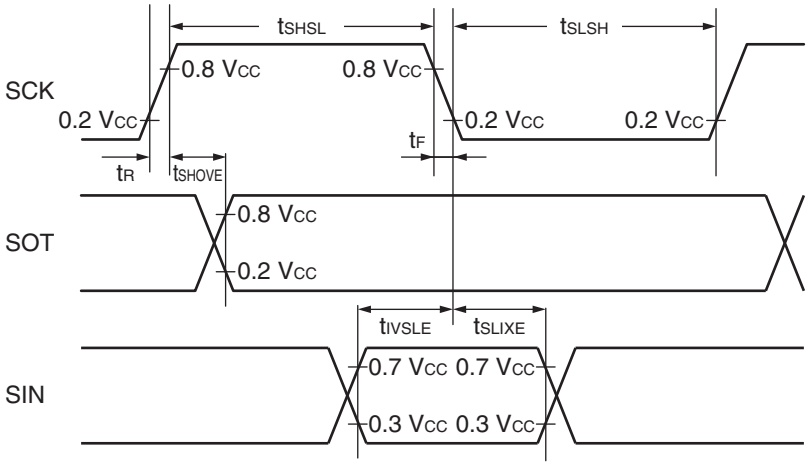
*: See “Source Clock/Machine Clock” for t_{MCLK}.

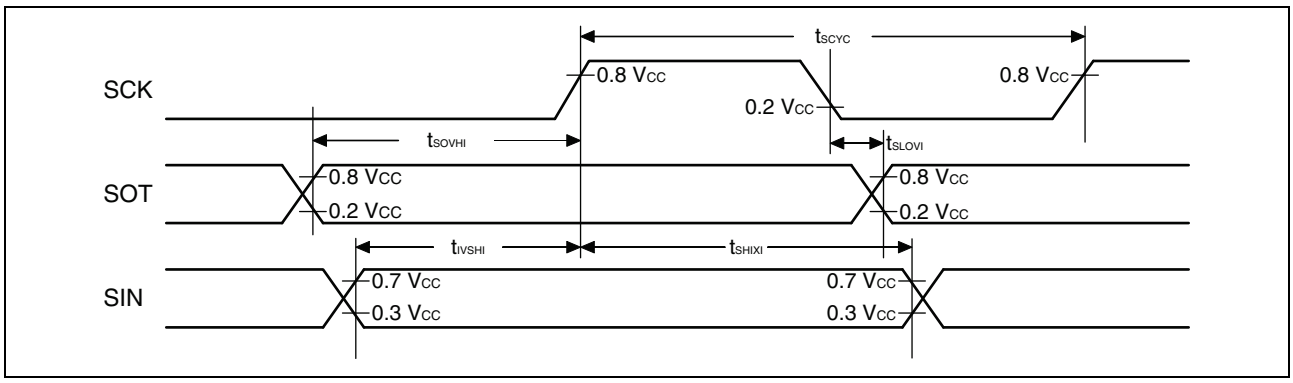


- Internal shift clock mode



- External shift clock mode





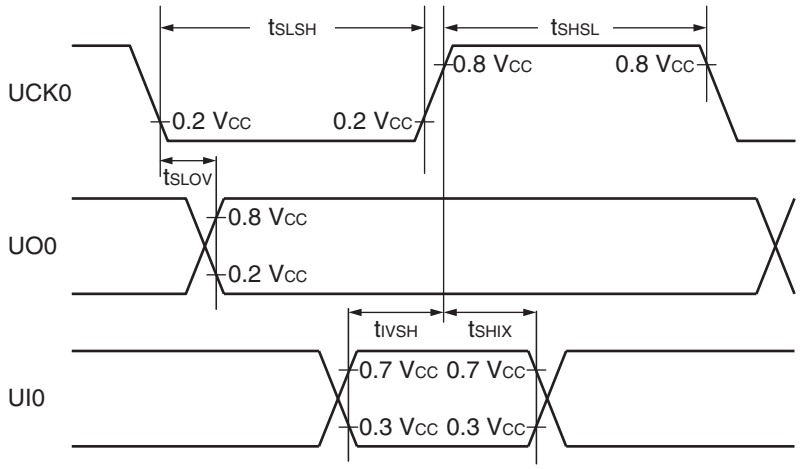
18.4.7 Low-voltage Detection

(V_{SS} = 0.0 V, T_A = –40°C to +85°C)

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Release voltage*	V_{DL+}	2.52	2.7	2.88	V	At power supply rise
		2.61	2.8	2.99		
		2.89	3.1	3.31		
		3.08	3.3	3.52		
Detection voltage*	V_{DL-}	2.43	2.6	2.77	V	At power supply fall
		2.52	2.7	2.88		
		2.80	3	3.20		
		2.99	3.2	3.41		
Hysteresis width	V_{HYS}	—	—	100	mV	
Power supply start voltage	V_{off}	—	—	2.3	V	
Power supply end voltage	V_{on}	4.9	—	—	V	
Power supply voltage change time (at power supply rise)	t_r	650	—	—	µs	Slope of power supply that the reset release signal generates within the rating (V_{DL+})
Power supply voltage change time (at power supply fall)	t_f	650	—	—	µs	Slope of power supply that the reset detection signal generates within the rating (V_{DL-})
Reset release delay time	t_{d1}	—	—	30	µs	
Reset detection delay time	t_{d2}	—	—	30	µs	
LVD reset threshold voltage transition stabilization time	t_{stb}	10	—	—	µs	

*: The release voltage and the detection voltage can be selected by using the LVD reset voltage selection ID register (LVDR) in the low-voltage detection reset circuit. For details of the LVDR register, refer to “CHAPTER 16 LOW-VOLTAGE DETECTION RESET CIRCUIT” in “New 8FX MB95630H Series Hardware Manual”.

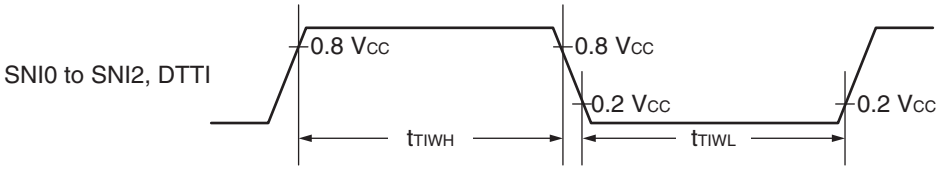
- External shift clock mode



18.4.10 MPG Input Timing

(V_{CC} = 5.0 V±10%, V_{SS} = 0.0 V, T_A = –40°C to +85°C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TIWH}, t_{TIWL}	SNI0 to SNI2, DTTI	—	4 t_{MCLK}	—	ns	



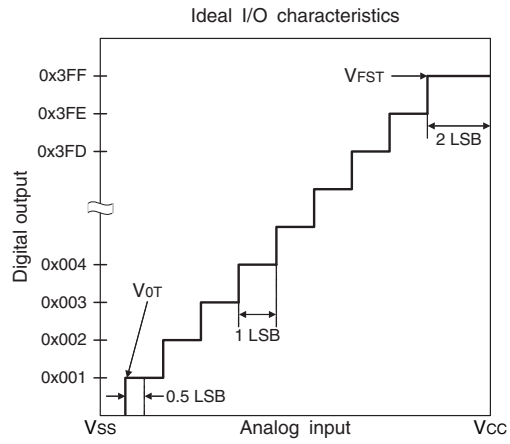
18.4.11 Comparator Timing

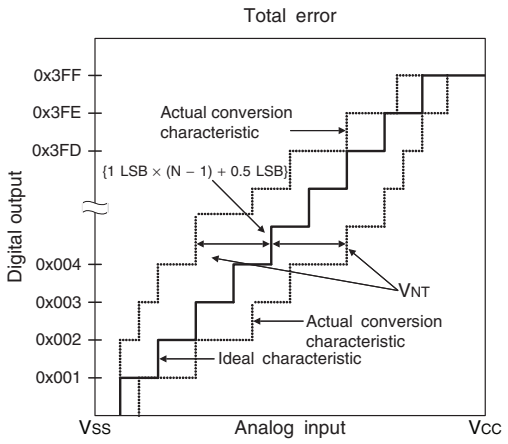
(V_{CC} = 2.4 V to 5.5 V, V_{SS} = 0.0 V, T_A = –40°C to +85°C)

Parameter	Pin name	Value			Unit	Remarks
		Min	Typ	Max		
Voltage range	CMP0_P, CMP0_N	0	—	V_{CC} – 1.3	V	
Offset voltage	CMP0_P, CMP0_N	–15	—	+15	mV	
Delay time	CMP0_O	—	650	1200	ns	Overdrive 5 mV
		—	140	420	ns	Overdrive 50 mV
Power down delay	CMP0_O	—	—	1200	ns	Power down recovery PD: 1 → 0
Power up stabilization time	CMP0_O	—	—	1200	ns	Output stabilization time at power up

18.5.3 Definitions of A/D Converter Terms

- Resolution
  It indicates the level of analog variation that can be distinguished by the A/D converter.
  When the number of bits is 10, analog voltage can be divided into 2^{10} = 1024.
- Linearity error (unit: LSB)
  It indicates how much an actual conversion value deviates from the straight line connecting the zero transition point ("0000000000" ← → "0000000001") of a device to the full-scale transition point ("1111111111" ← → "1111111110") of the same device.
- Differential linear error (unit: LSB)
  It indicates how much the input voltage required to change the output code by 1 LSB deviates from an ideal value.
- Total error (unit: LSB)
  It indicates the difference between an actual value and a theoretical value. The error can be caused by a zero transition error, a full-scale transition errors, a linearity error, a quantum error, or noise.





$$1\ \text{LSB} = \frac{V_{CC} - V_{SS}}{1024}\ \text{V}$$

$$\text{Total error of digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N - 1) + 0.5\ \text{LSB}\}}{1\ \text{LSB}}\ \text{LSB}$$

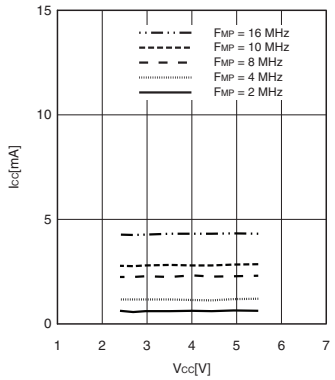
N : A/D converter digital output value

V_{NT} : Voltage at which the digital output transits from 0x(N – 1) to 0xN

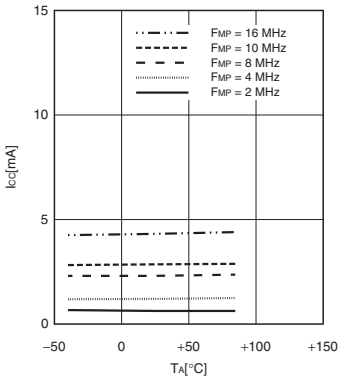
19. Sample Characteristics

- Power supply current temperature characteristics

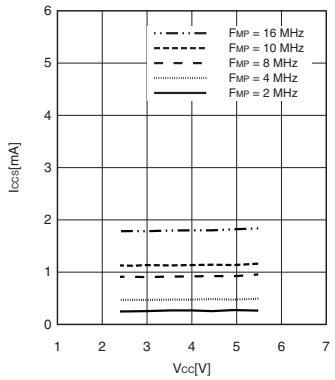
I_{CC} – V_{CC}
T_A = +25°C, F_{MP} = 2, 4, 8, 10, 16 MHz (divided by 2)
Main clock mode with the external clock operating



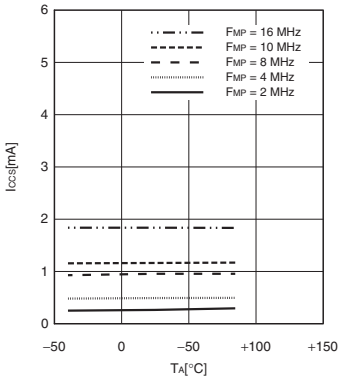
I_{CC} – T_A
V_{CC} = 5.5 V, F_{MP} = 2, 4, 8, 10, 16 MHz (divided by 2)
Main clock mode with the external clock operating



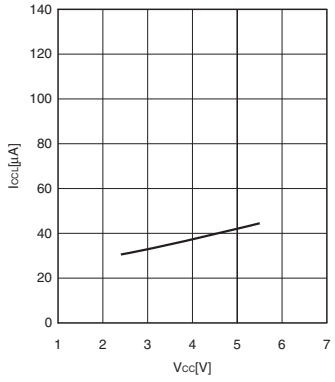
I_{CCS} – V_{CC}
T_A = +25°C, F_{MP} = 2, 4, 8, 10, 16 MHz (divided by 2)
Main sleep mode with the external clock operating



I_{CCS} – T_A
V_{CC} = 5.5 V, F_{MP} = 2, 4, 8, 10, 16 MHz (divided by 2)
Main sleep mode with the external clock operating



I_{CCL} – V_{CC}
T_A = +25°C, F_{MPL} = 16 kHz (divided by 2)
Subclock mode with the external clock operating



I_{CCL} – T_A
V_{CC} = 5.5 V, F_{MPL} = 16 kHz (divided by 2)
Subclock mode with the external clock operating